



RAYSTAR

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RFG570F-ALW-DNN

SPECIFICATION

CUSTOMER:

APPROVED BY	
PCB VERSION	
DATE	

FOR CUSTOMER USE ONLY

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY

Release DATE:

TFT Display Inspection Specification: <https://www.raystar-optronics.com/download/products.htm>

Precaution in use of TFT module: <https://www.raystar-optronics.com/download/declaration.htm>

Revision History

VERSION	DATE	REVISED PAGE NO.	Note
0	2013/02/04		First issue
A	2013/05/21		Modify Resolution:640x480
B	2015/08/20		Add Package Specification. Update Rev. Add size & Surface. Modify Block Diagram Modify Reliability.
C	2016/01/21		Modify Static electricity test
D	2016/08/11		Modify Vibration test
E	2016/11/17		Modify Summary
F	2018/01/15		Modify LED driving conditions
G	2020/02/19		Modify Brightness Add Pull Tape

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1.Module Classification Information

R	F	G	57	0F	-	A	L	W	-	D	N	N
1	2	3	4	5	-	6	7	8	-	9	10	11

Item	Description	
1	R : Raystar Optonics Inc.	
2	Display Type : F→TFT Type, J→ Custom TFT	
3	Solution: A: 128x160 B:320x234 C:320x240 D:480x234 E:480x272 F:800x480 G:640x480 H:1024x600 I:320x480 J:240x320 K:1280x800 L:240x400 M:1024x768 N:128x128 O:480x800 P:640x320 Q:800x600 S:480x128 T:800x320	
4	Display Size : 5.7" TFT	
5	Version Code.	
6	Model Type: A : TFT LCD E : TFT+FR+CONTROL BOARD J : TFT+FR+A/D BOARD N : TFT+FR+A/D BOARD+CONTROL BOARD S : TFT+FR+POWER BOARD (DC TO DC) 1 : TFT+CONTROL BOARD	6 : TFT+FR H : TFT+D/V BOARD I : TFT+FR+D/V BOARD B : TFT+POWER BD
7	Polarizer Type, Temperature range, View direction	I→Transmissive, W. T, 6:00 ; C→Transmissive, N. T, 6:00 L→Transmissive, W.T,12:00 ; F→Transmissive, N.T,12:00 Y→Transmissive,W.T, IPS TFT ; A→Transmissive, N.T, IPS TFT Z→Transmissive, W.T, O-TFT R→Transmissive, Super W.T, O-TFT N→Transmissive, Super W.T, 6:00; Q→Transmissive, Super W.T, 12:00 V→Transmissive, Super W.T, VA TFT
8	Backlight	W : LED, White H : LED, High Light White F : CCFL, White
9	Driver Method	D: Digital A: Analog L : LVDS M:MIPI
10	Interface	N : without control board A : 8Bit B : 16Bit S:SPI Interface R: RS232 U:USB I: I2C
11	TS	N : Without TS S : resistive touch panel C : capacitive touch panel capacitive touch panel (G-F-F) G : capacitive touch panel(G-G)

2.Summary

TFT 5.7” is a TN transmissive type color active matrix TFT liquid crystal display that use amorphous silicon TFT as switching devices. This module is a composed of a TFT_LCD module, It is usually designed for industrial application and this module follows RoHs,

RAYSTAR OPTRONICS

3.General Specifications

- Size: 5.7 inch
- Dot Matrix: 640 x RGBx480(TFT) dots
- Module dimension: 125.0 x 98.8 x 5.95
- Active area: 115.2 x 86.4 mm
- Dot pitch: 0.06 x 0.18 mm
- LCD type: TFT, Normally White, Transmissive
- View Direction: 6 o'clock
- Gray Scale Inversion Direction: 12 o'clock
- Aspect Ratio: 4:3
- Backlight Type: LED ,Normally White
- With /Without TP: Without TP
- Surface: Glare

*Color tone slight changed by temperature and driving voltage.

4.Interface

4.1. LCM PIN Definition

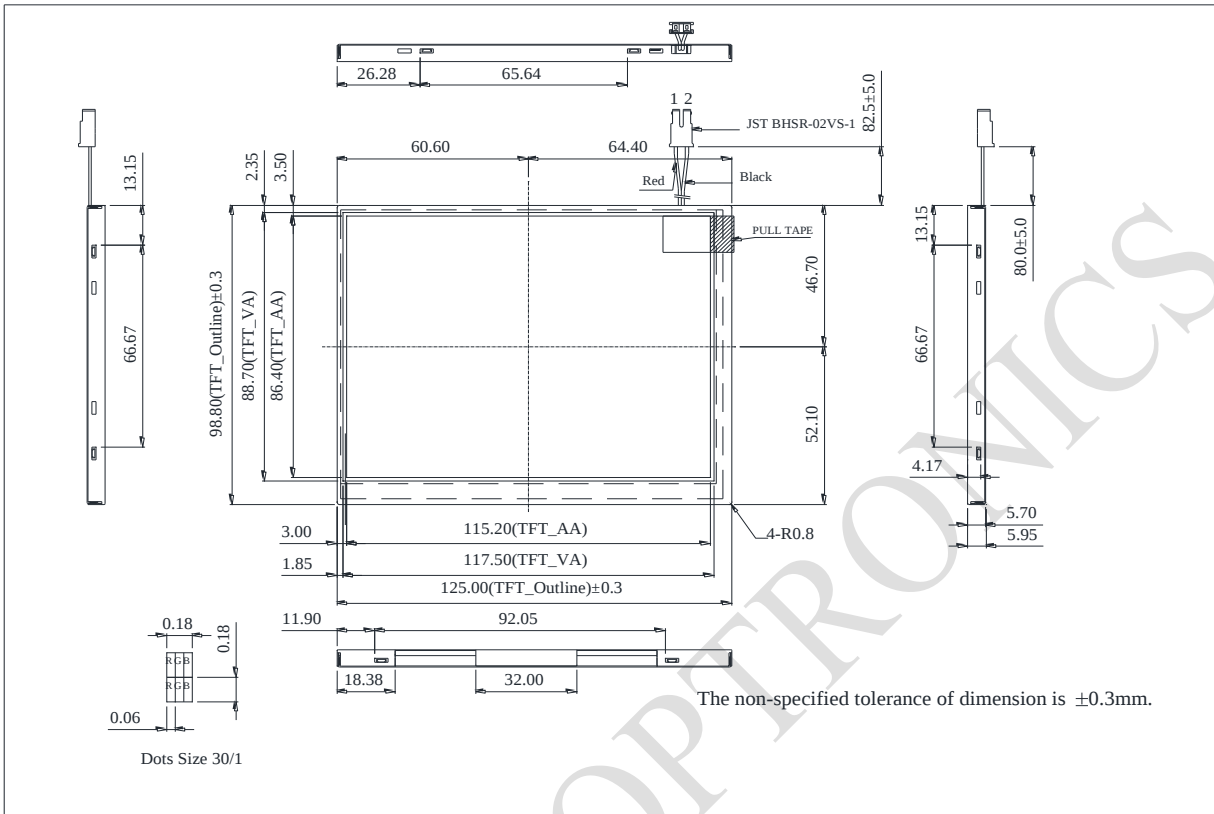
Pin	Symbol	Function	Remark
1	DGND	Ground for digital circuit	
2	VCC	Power Supply : +3.3V	
3	VCC	Power Supply : +3.3V	
4	DGND	Ground for digital circuit	
5	VGL	Gate off power	
6	DGND	Ground for digital circuit	
7	VGH	Gate on power	
8	DGND	Ground for digital circuit	
9	UD	Up/down selection	
10	LR	Left /right selection	
11	SPENA	Chip select	
12	SPCK	Serial Clock	
13	SPDA	Serial Data	
14	NC	No connect	
15	DGND	Ground for digital circuit	
16	B5	Blue Data bus	
17	B4	Blue Data bus	
18	B3	Blue Data bus	
19	B2	Blue Data bus	
20	B1	Blue Data bus	
21	B0	Blue Data bus	
22	NC(TOP)	No connection	
23	NC(RIGHT)	No connection	
24	DGND	Ground for digital circuit	
25	G5	Green Data bit	
26	G4	Green Data bit	
27	G3	Green Data bit	
28	G2	Green Data bit	
29	G1	Green Data bit	
30	G0	Green Data bit	
31	NC(BOTTOM)	No connection	
32	NC(LEFT)	No connection	
33	AGND	Ground	

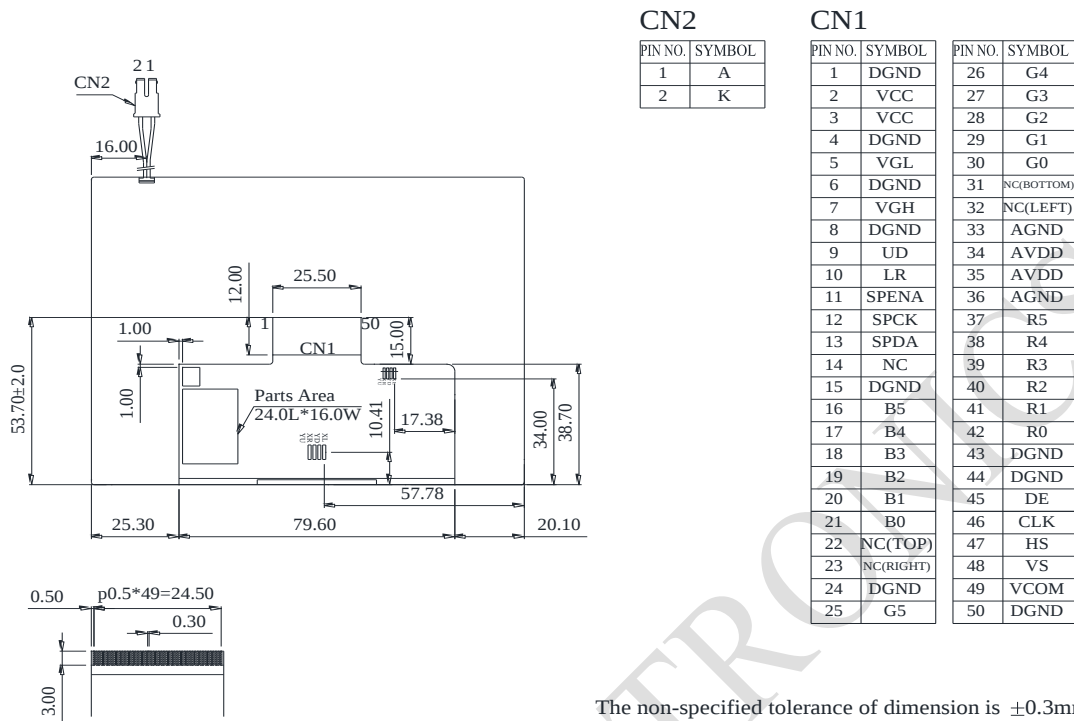
34	AVDD	Analog power: 10V	
35	AVDD	Analog power: 10V	
36	AGND	Ground	
37	R5	Red Data bit	
38	R4	Red Data bit	
39	R3	Red Data bit	
40	R2	Red Data bit	
41	R1	Red Data bit	
42	R0	Red Data bit	
43	DGND	Ground for digital circuit	
44	DGND	Ground for digital circuit	
45	DE	Data Enable input	
46	CLK	Data Clock	
47	HS	Horizontal sync input	
48	VS	Vertical sync input	
49	VCOM	VCOM driving input	
50	DGND	Ground for digital circuit	

4.2. Backlight PIN Definition

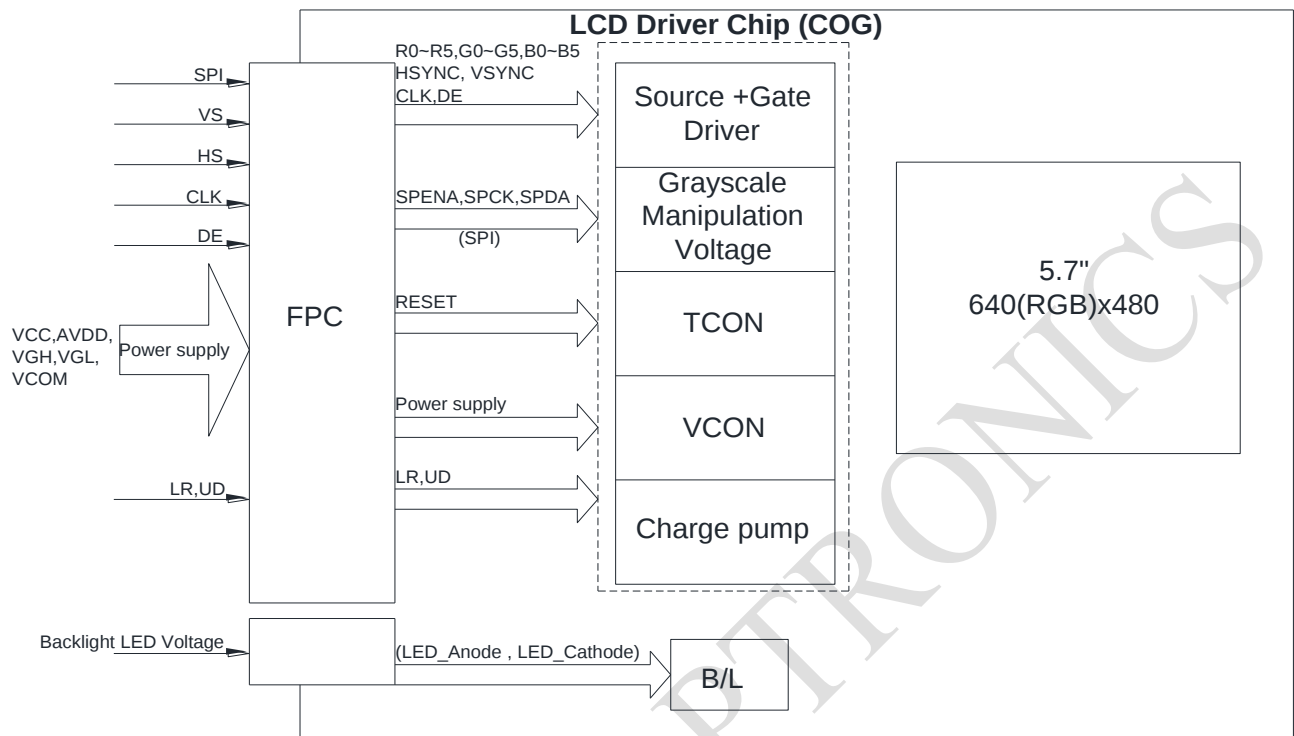
Pin No.	Symbol	Description
1	A	Red, LED Anode
2	K	Black, LED Cathode

5. Contour Drawing





6. Block Diagram



6.1.

7. Absolute Maximum Ratings

Item	Symbol	Min	Typ	Max	Unit
Operating Temperature	TOP	-20	—	+70	°C
Storage Temperature	TST	-30	—	+80	°C

Note: Device is subject to be damaged permanently if stresses beyond those absolute maximum ratings listed above

- Temp. $\leq 60^{\circ}\text{C}$, 90% RH MAX. Temp. $> 60^{\circ}\text{C}$, Absolute humidity shall be less than 90% RH at 60°C

8. Electrical Characteristics

8.1. Operating conditions:

Item	Symbol	Condition	Min	Typ	Max	Unit
Supply Voltage For LCM	VCC	—	3.0	3.3	3.6	V
Supply Current For LCM	ICC	-	—	9	—	mA
Power Consumption	-	-	—	29.7	—	mW
Power Supply for Analog	AVDD	AVDD-AGND	10.5		11	V
Input Voltage	VIH	H Level	0.7VCC	—	VCC	V
	VIL	L Level	0	—	0.3VCC	V
Recommended LC Driving Voltage for 25°C	VGH	(Note)	13	16	17	V
	VGL		-8	-7	-6	V
	VCOM		3.97	4.02	4.07	V

Note 1 : This value is test for VDD=3.3V , Ta=25 °C only

(1) VGH is TFT Gate on operating Voltage.

(2) VGH is TFT Gate off operating Voltage ,VGL signal must be fluctuates with same phase as VCOM

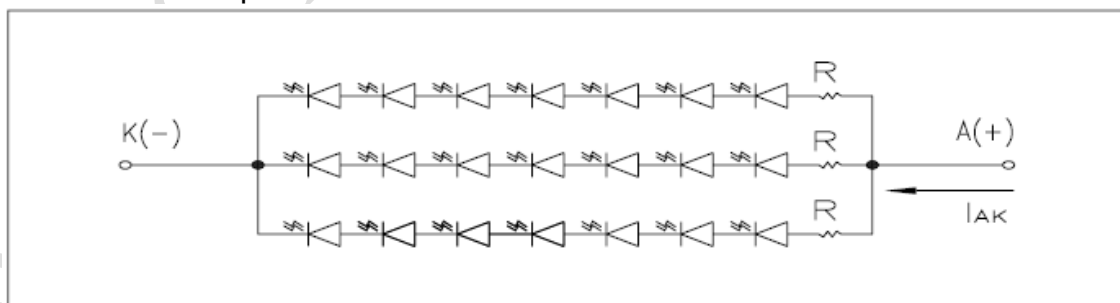
when Storage on Gate structure.

(3) VCOM must be adjusted to optimize display quality Crosstalk , Contrast Ratio and etc

8.2. LED driving conditions

Parameter	Symbol	Min.	Typ.	Max.	Unit	Remark
LED current	-	-	60	-	mA	-
Power Consumption	-	-	1386	1479	mW	-
LED voltage	VBL+	18.9	23.1	24.5	V	Note 1
LED Life Time	-	-	50,000	-	Hr	Note 2,3,4

Note 1 : There are 1 Groups LED



Note 2 : Ta = 25 °C

Note 3 : Brightness to be decreased to 50% of the initial value

Note 4 : The single LED lamp case

9.DC CHARATERISTICS

Parameter	Symbol	Rating			Unit	Condition
		Min	Typ	Max		
Low level input voltage	V_{IL}	0	-	0.3VCC	V	
High level input voltage	V_{IH}	0.7VCC	-	VCC	V	

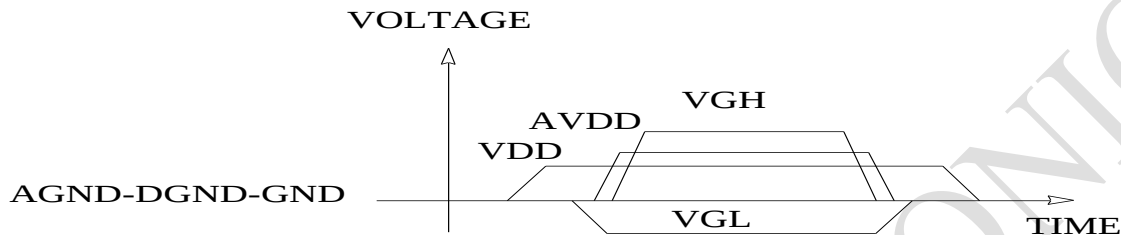
10. Timing Characteristics

10.1. AC TIMING CHARACTERISTICS

Please refer to the IC SPEC : (Himax) HX8250-A01B
(Himax) HX8678-A000

10.2. POWER ON/OFF SEQUENCE

To prevent the device damage from latch up, the power ON/OFF sequence shown below must be followed.



(NOET) DISPLAY DIRECTION OF THE PANEL

The UD and LR control the Display direction of the panel .
The settings of UD and LR are or following:



(1) UD=VDD and LR=DGND



(2) UD=VDD and LR=VDD



(3) UD= DGND and LR=DGND



(4) UD= DGND and LR= VDD

11. Optical Characteristics

Item		Symbol	Condition.	Min	Typ	Max	Unit	Remark
Response time		Tr+ Tf	$\theta=0^{\circ}$ 、 $\Phi=0^{\circ}$	-	15	-	ms	Note 3,5
				-	35	-		
Contrast ratio		CR	At optimized viewing angle	150	250	-	-	Note 4,5
Color Chromaticity	White	Wx	$\theta=0^{\circ}$ 、 $\Phi=0$	0.28	0.31	0.34	-	Note 2,6,7
		Wy		0.32	0.35	0.38	-	
Viewing angle (Gray Scale Inversion Direction)	Hor.	ΘR	$CR \geq 10$	-	60	-	Deg.	Note 1
		ΘL		-	60	-		
	Ver.	ΦT		-	60	-		
		ΦB		-	40	-		
Brightness		-	-	400	500	-	cd/m ²	Center of display

Ta=25±2℃, IL=60mA

Note 1: Definition of viewing angle range

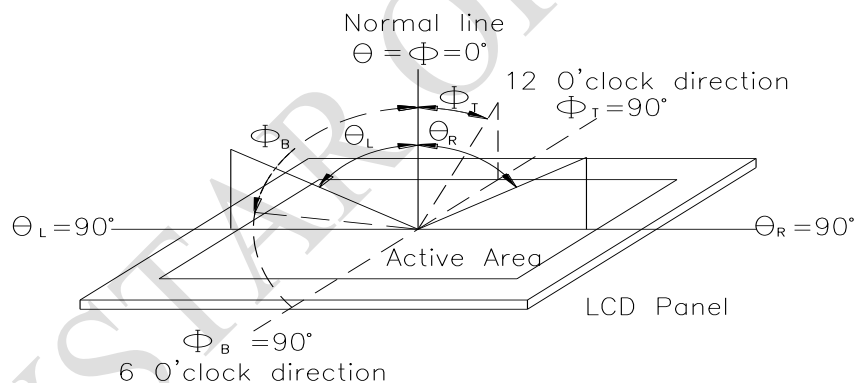


Fig.11.1. Definition of viewing angle

Note 2: Test equipment setup:

After stabilizing and leaving the panel alone at a driven temperature for 10 minutes, the measurement should be executed. Measurement should be executed in a stable, windless, and dark room. Optical specifications are measured by Topcon BM-7orBM-5 luminance meter 1.0° field of view at a distance of 50cm and normal direction.

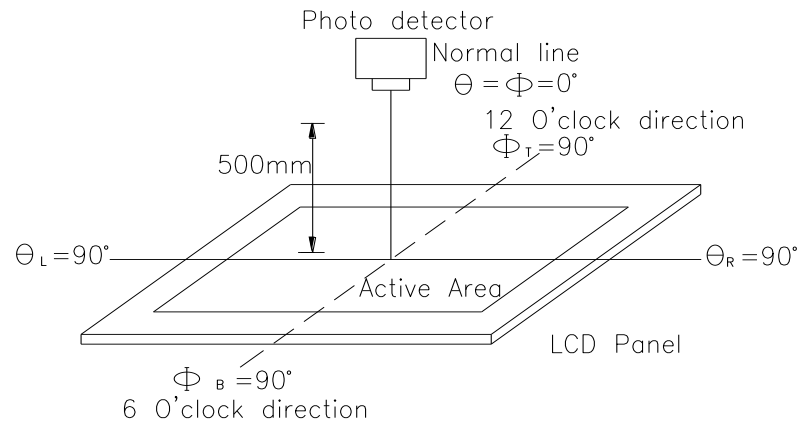
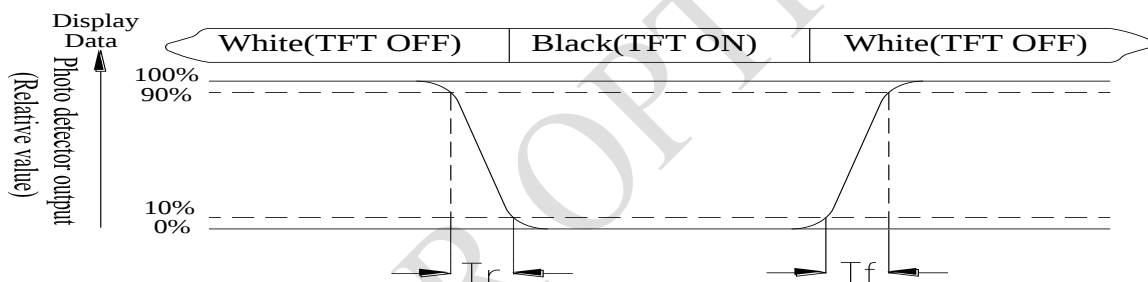


Fig. 11.2. Optical measurement system setup

Note 3: Definition of Response time:

The response time is defined as the LCD optical switching time interval between “White” state and “Black” state. Rise time, T_r , is the time between photo detector output intensity changed from 90% to 10%. And fall time, T_f , is the time between photo detector output intensity changed from 10% to 90%



Note 4: Definition of contrast ratio:

The contrast ratio is defined as the following expression.

$$\text{Contrast ratio (CR)} = \frac{\text{Luminance measured when LCD on the "White" state}}{\text{Luminance measured when LCD on the "Black" state}}$$

Note 5: White $V_i = V_{i50} \pm 1.5V$

Black $V_i = V_{i50} \pm 2.0V$

“ $\pm$ ” means that the analog input signal swings in phase with VCOM signal.

“ $\pm$ ” means that the analog input signal swings out of phase with VCOM signal.

The 100% transmission is defined as the transmission of LCD panel when all the input terminals of module are electrically opened.

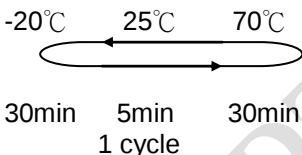
Note 6: Definition of color chromaticity (CIE 1931)

Color coordinates measured at the center point of LCD

Note 7: Measured at the center area of the panel when all the input terminals of LCD panel are electrically opened.

12. Reliability

Content of Reliability Test (Wide temperature, -20°C~70°C)

Environmental Test			
Test Item	Content of Test	Test Condition	Note
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs	—
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1
High Temperature/ Humidity Operation	The module should be allowed to stand at 60°C,90%RH max	60°C,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation 	-20°C/70°C 10 cycles	—
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude : 3 1.5mm Vibration Frequency : 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=±600V(contact) ,±800v(air), RS=330Ω CS=150pF 10 times	—

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

LCM Sample Estimate Feedback Sheet		
Module Number : _____		
1 、 <u>Panel Specification</u> :		
1. Panel Type :	☐ Pass	☐ NG , _____
2. View Direction :	☐ Pass	☐ NG , _____
3. Numbers of Dots :	☐ Pass	☐ NG , _____
4. View Area :	☐ Pass	☐ NG , _____
5. Active Area :	☐ Pass	☐ NG , _____
6. Operating Temperature :	☐ Pass	☐ NG , _____
7. Storage Temperature :	☐ Pass	☐ NG , _____
8. Others : _____		
2 、 <u>Mechanical Specification</u> :		
1. PCB Size :	☐ Pass	☐ NG , _____
2. Frame Size :	☐ Pass	☐ NG , _____
3. Material of Frame :	☐ Pass	☐ NG , _____
4. Connector Position :	☐ Pass	☐ NG , _____
5. Fix Hole Position :	☐ Pass	☐ NG , _____
6. Backlight Position :	☐ Pass	☐ NG , _____
7. Thickness of PCB :	☐ Pass	☐ NG , _____
8. Height of Frame to PCB :	☐ Pass	☐ NG , _____
9. Height of Module :	☐ Pass	☐ NG , _____
10. Others :	☐ Pass	☐ NG , _____
3 、 <u>Relative Hole Size</u> :		
1. Pitch of Connector :	☐ Pass	☐ NG , _____
2. Hole size of Connector :	☐ Pass	☐ NG , _____
3. Mounting Hole size :	☐ Pass	☐ NG , _____
4. Mounting Hole Type :	☐ Pass	☐ NG , _____
5. Others :	☐ Pass	☐ NG , _____
4 、 <u>Backlight Specification</u> :		
1. B/L Type :	☐ Pass	☐ NG , _____
2. B/L Color :	☐ Pass	☐ NG , _____
3. B/L Driving Voltage (Reference for LED Type) : ☐ Pass ☐ NG , _____		
4. B/L Driving Current :	☐ Pass	☐ NG , _____
5. Brightness of B/L :	☐ Pass	☐ NG , _____
6. B/L Solder Method :	☐ Pass	☐ NG , _____
7. Others :	☐ Pass	☐ NG , _____

>> Go to page 2 <<

Module Number : _____

5 、 Electronic Characteristics of Module :

1.Input Voltage :	☐ Pass	☐ NG , _____
2.Supply Current :	☐ Pass	☐ NG , _____
3.Driving Voltage for LCD :	☐ Pass	☐ NG , _____
4.Contrast for LCD :	☐ Pass	☐ NG , _____
5.B/L Driving Method :	☐ Pass	☐ NG , _____
6.Negative Voltage Output :	☐ Pass	☐ NG , _____
7.Interface Function :	☐ Pass	☐ NG , _____
8.LCD Uniformity :	☐ Pass	☐ NG , _____
9.ESD test :	☐ Pass	☐ NG , _____
10.Others :	☐ Pass	☐ NG , _____

6 、 Summary :
Sales signature : _____

Customer Signature : _____

Date : / /